

What is claimed is:

1     1.     A power supply noise analysis model generator adapted to model  
2     power supply layers in a circuit board, said generator comprising:

3         a CAD data obtaining section that obtains CAD data including  
4     information concerning a board shape, pattern shapes, and elements;

5         a CAD data conversion processing section that converts said CAD  
6     data into power supply island pattern data, element data, lead pattern data,  
7     and via pattern data;

8         a power supply pair extraction processing section that extracts, if two  
9     power supply islands existing in two different power supply layers, respectively,  
10    overlap each other, said two power supply islands as a power supply pair;

11        a node layout processing section that positions plural nodes on a  
12    power supply pair region which is occupied by each power supply pair on a  
13    plane of said circuit board;

14        a node region determination processing section that determines node  
15    regions surrounding said nodes, respectively;

16        an impedance parameter determination processing section that  
17    determines impedance parameters expressing relationships between said  
18    nodes, respectively;

19        a power supply layer model generation processing section that  
20    connects said nodes to each other using said impedance parameters, to  
21    generate a power supply layer model; and

22        a power supply noise analysis model generation processing section  
23    that connects said power supply layer model, said lead pattern data and said  
24    via pattern data to one another to generate a power supply noise analysis  
25    model.

1     2.     The power supply noise analysis model generator according to claim 1,

2 wherein said impedance parameters are a reactance L, a resistance R, and an  
3 interlayer capacitance C.

1 3. The power supply noise analysis model generator according to claim 1,  
2 wherein if a power supply pair space sandwiched between power supplies of  
3 an observed power supply pair is contacted or overlapped by another power  
4 supply pair space of any other power supply pair, said power supply pair  
5 extraction processing section makes said observed power supply pair and said  
6 other power supply pair into a group.

1 4. The power supply noise analysis model generator according to claim 1,  
2 further comprising a ripple processing section that positions, on said power  
3 supply pair region, ripples which are wave fronts of electromagnetic waves  
4 radiated into said power supply pair region from said elements, wherein said  
5 node layout processing section positions said nodes, based on pitches of said  
6 ripples.

1 5. The power supply noise analysis model generator according to claim 4,  
2 wherein said ripple processing section uses rising or falling times of those of  
3 said elements which are mounted on said power supply pair region, maximum  
4 operating frequencies of those elements, and areas of said ripples, to calculate  
5 intervals between said ripples.

1 6. The power supply noise analysis model generator according to claim 4,  
2 wherein said ripple processing section spreads said ripples into power supply  
3 pair regions of power supply pairs which belong to a group.

1 7. The power supply noise analysis model generator according to claim 4,  
2 further comprising a ripple display processing section that searches for outline

3 coordinates of said ripples, and displays said ripples with the use of said  
4 outline coordinates.

1 8. The power supply noise analysis model generator according to claim 1,  
2 further comprising a mesh division processing section that divides said power  
3 supply pair region with the use of meshes based on a wavelength of one of  
4 said elements mounted that has the highest operating frequency.

1 9. The power supply noise analysis model generator according to claim 8,  
2 further comprising an internal data storage which stores information for every  
3 of said meshes into a table on which coordinates on said circuit board  
4 correspond to addresses.

1 10. The power supply noise analysis model generator according to claim 9,  
2 wherein the information for every of said meshes includes at least one of a  
3 ripple level which indicates the number of ripples from an element to a  
4 corresponding mesh, the presence or absence of a node in said corresponding  
5 mesh, and a node region identifier expressing a node region to which said  
6 corresponding mesh belongs.

1 11. The power supply noise analysis model generator according to claim 1,  
2 wherein, taking a most adjacent node as the node closest to an observed node  
3 within a sector having a predetermined radius about said observed node as the  
4 center of said sector, said node region determination processing section  
5 searches for adjacent nodes by rotating said sector about said observed node.

1 12. The power supply noise analysis model generator according to claim  
2 11, wherein said node region determination processing section removes a  
3 square from said power supply pair region thereby to determine an edge of the

4 node region of said observed node with respect to said most adjacent node,  
5 said square having as an edge a perpendicular bisector of a predetermined  
6 length between said observed node and said most adjacent node and  
7 containing said most adjacent node, so that edges of said node region of said  
8 observed node are sequentially determined with respect to all the adjacent  
9 nodes, respectively, in the order of increasing distance from said most  
10 adjacent node, finally to determine the node region of said observed node.

1 13. The power supply noise analysis model generator according to claim 1,  
2 wherein said impedance parameter determination processing section  
3 determines a reactance L and a resistance R based on distances between said  
4 nodes, and determines an interlayer capacitance C with the use of the areas of  
5 said node regions and a distance or distances between power supply layers,  
6 and said power supply layer model generation processing section arranges  
7 said reactance L and said resistance R between nodes on an upper surface of  
8 each power supply pair and between nodes on a lower surface of each power  
9 supply pair, and arranges each interlayer capacitance C between such a  
10 couple of nodes that are arranged at equal positions respectively on the upper  
11 and lower surfaces of said power supply pair.

1 14. The power supply noise analysis model generator according to claim 1,  
2 further comprising a power supply noise analysis model storage that stores  
3 said power supply noise analysis model.

1 15. The power supply noise analysis model generator according to claim 1,  
2 wherein said power supply noise analysis model generation processing section  
3 further generates a total circuit model in which said power supply noise  
4 analysis model is connected to said element data, and stores said total circuit  
5 model into said power supply noise analysis model storage.

1 16. A power supply noise analysis model generator which models a power  
2 supply layer in a circuit board, said generator comprising:

3 a power supply pair extraction processing section that extracts, as a  
4 power supply pair, different two power supply layers overlapping each other in  
5 a layering direction from data indicative of said circuit board; and

6 a power supply noise analysis model generation processing section  
7 that uses said power supply pair extracted to generate a power supply noise  
8 analysis model.

1 17. A power supply noise analysis model generation method of modeling  
2 power supply layers in a circuit board, said method comprising:

3 a step of obtaining CAD data including information concerning a board  
4 shape, pattern shapes, and elements;

5 a step of converting said CAD data into power supply island pattern  
6 data, element data, lead pattern data, and via pattern data;

7 a step of extracting, if two power supply islands existing in two different  
8 layers, respectively, overlap each other, said two power supply islands as a  
9 power supply pair;

10 a step of positioning plural nodes on a power supply pair region which  
11 is occupied by each power supply pair on a plane of said circuit board;

12 a step of determining node regions surrounding said nodes,  
13 respectively;

14 a step of determining impedance parameters expressing relationships  
15 between said nodes, respectively;

16 a step of connecting said nodes to each other using said impedance  
17 parameters, to generate a power supply layer model; and

18 a step of connecting said power supply layer model, said lead pattern  
19 data, and said via pattern data to one another to generate a power supply  
20 noise analysis model.

1 18. The power supply noise analysis model generation method according  
2 to claim 17, wherein said impedance parameters are a reactance L, a  
3 resistance R, and an interlayer capacitance C.

1 19. The power supply noise analysis model generation method according  
2 to claim 17, wherein in said step of extracting a power supply pair, if a power  
3 supply pair space sandwiched between power supplies of an observed power  
4 supply pair is contacted or overlapped by another power supply pair space of  
5 any other power supply pair, said observed power supply pair and said other  
6 power supply pair are made into a group.

1 20. The power supply noise analysis model generation method according  
2 to claim 17, further comprising a step of positioning, on said power supply pair  
3 region, ripples which are wave fronts of electromagnetic waves radiated into  
4 said power supply pair region from said elements, wherein in said step of  
5 positioning plural nodes, said nodes are positioned based on pitches of said  
6 ripples.

1 21. The power supply noise analysis model generation method according  
2 to claim 20, wherein in said step of positioning ripples, rising or falling times of  
3 those of said elements which are mounted on said power supply pair region,  
4 maximum operating frequencies of those elements, and areas of regions of  
5 said ripples are used to calculate said ripples.

1 22. The power supply noise analysis model generation method according  
2 to claim 20, wherein in said step of positioning ripples, said ripples are spread  
3 into power supply pair regions of power supply pairs which belong to a group.

1 23. The power supply noise analysis model generation method according

2 to claim 20, further comprising a step of searching for outline coordinates of  
3 said ripples, and displaying said ripples with the use of said outline  
4 coordinates.

1 24. The power supply noise analysis model generation method according  
2 to claim 17, further comprising a step of dividing said power supply pair region  
3 with the use of meshes based on a wavelength of one of said elements  
4 mounted that has the highest operating frequency.

1 25. The power supply noise analysis model generation method according  
2 to claim 24, further comprising a step of storing information for every of said  
3 meshes into a table on which coordinates on said circuit board correspond to  
4 addresses.

1 26. The power supply noise analysis model generation method according  
2 to claim 25, wherein said information for every of said meshes includes at least  
3 one of a ripple level which indicates the number of ripples from an element to a  
4 corresponding mesh, the presence or absence of a node in said corresponding  
5 mesh, and a node region identifier expressing a node region to which said  
6 corresponding mesh belongs.

1 27. A power supply noise analysis model generation method of modeling a  
2 power supply layer in a circuit board, said method comprising:  
3 a step of extracting, as a power supply pair, different two power supply  
4 layers overlapping each other in a layering direction from data indicative of  
5 said circuit board; and  
6 a step of generating a power supply noise analysis model by using  
7 said power supply pair thus extracted.

1 28. A power supply noise analysis model generation program stored in a  
2 medium readable by a computer to make said computer execute modeling  
3 power supply layers in a circuit board, said program being operable to make  
4 the computer execute:

5 a step of obtaining CAD data including information concerning a board  
6 shape, pattern shapes, and elements;

7 a step of converting said CAD data into power supply island pattern  
8 data, element data, lead pattern data, and via pattern data;

9 a step of extracting, if two power supply islands existing in two different  
10 layers, respectively, overlap each other, said two power supply islands as a  
11 power supply pair;

12 a step of positioning plural nodes on a power supply pair region which  
13 is occupied by each power supply pair on a plane of said circuit board;

14 a step of determining node regions surrounding said nodes,  
15 respectively;

16 a step of determining impedance parameters expressing relationships  
17 between said nodes, respectively;

18 a step of connecting said nodes to each other using said impedance  
19 parameters, to generate a power supply layer model; and

20 a step of connecting said power supply layer model, said lead pattern  
21 data, and said via pattern data to one another to generate a power supply  
22 noise analysis model.

1 29. The power supply noise analysis model generation program according  
2 to claim 28, wherein said impedance parameters are a reactance  $L$ , a  
3 resistance  $R$ , and an interlayer capacitance  $C$ .

1 30. The power supply noise analysis model generation program according  
2 to claim 28, wherein in said step of extracting a power supply pair, if a power



3 supply pair space sandwiched between power supplies of an observed power  
4 supply pair is contacted or overlapped by another power supply pair space of  
5 any other power supply pair, said observed power supply pair and said other  
6 power supply pair are made into a group.

1 31. The power supply noise analysis model generation program according  
2 to claim 28, further comprising a step of making said computer execute  
3 positioning, on said power supply pair region, ripples which are wave fronts of  
4 electromagnetic waves radiated into said power supply pair region from said  
5 elements, wherein in said step of positioning plural nodes, said nodes are  
6 positioned based on pitches of said ripples.

1 32. The power supply noise analysis model generation program according  
2 to claim 31, wherein in said step of positioning ripples, rising or falling times of  
3 those of said elements which are mounted on said power supply pair region,  
4 maximum operating frequencies of those elements, and areas of regions of  
5 said ripples are used to calculate said ripples.

1 33. The power supply noise analysis model generation program according  
2 to claim 31, wherein in said step of positioning ripples, said ripples are spread  
3 into power supply pair regions of power supply pairs which belong to a group.

1 34. The power supply noise analysis model generation program according  
2 to claim 31, further comprising a step of making said computer execute  
3 searching for outline coordinates of said ripples, and displaying said ripples  
4 with the use of said outline coordinates.

1 35. The power supply noise analysis model generation program according  
2 to claim 28, further comprising a step of making said computer execute

3 dividing said power supply pair region with the use of meshes based on a  
4 wavelength of one of said elements mounted that has the highest operating  
5 frequency.

1 36. The power supply noise analysis model generation program according  
2 to claim 35, further comprising a step of making said computer execute storing  
3 information for every of said meshes into a table on which coordinates on said  
4 circuit board correspond to addresses.

1 37. The power supply noise analysis model generation program according  
2 to claim 36, wherein said information for every of said meshes includes at least  
3 one of a ripple level which indicates the number of ripples from an element to a  
4 corresponding mesh, the presence or absence of a node in said corresponding  
5 mesh, and a node region identifier expressing a node region to which said  
6 corresponding mesh belongs.

1 38. The power supply noise analysis model generation program stored in a  
2 medium readable by a computer to make said computer execute modeling a  
3 power supply layer in a circuit board, said program being operable to make  
4 said computer execute:

5 a step of extracting, as a power supply pair, different two power supply  
6 layers overlapping each other in a layering direction from data indicative of  
7 said circuit board; and

8 a step of using said power supply pair thus extracted, to generate a  
9 power supply noise analysis model.